

**General Description**

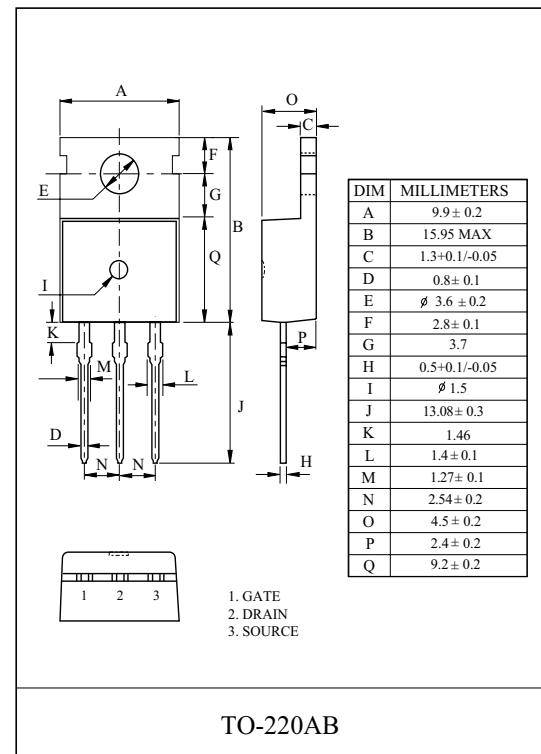
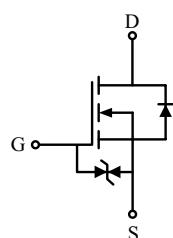
This planar stripe MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for electronic ballast and switching mode power supplies.

**FEATURES**

- $V_{DSS} = 500V$ ,  $I_D = 5.0A$
- Drain-Source ON Resistance :  $R_{DS(ON)} = 1.4$  @  $V_{GS} = 10V$
- $Q_g(\text{typ}) = 12\text{nC}$

**MAXIMUM RATING (T<sub>c</sub>=25 )**

| CHARACTERISTIC                          | SYMBOL     | RATING   | UNIT |
|---|------------|----------|------|
| Drain-Source Voltage                    | $V_{DSS}$  | 500      | V    |
| Gate-Source Voltage                     | $V_{GSS}$  | $\pm 30$ | V    |
| Drain Current                           | $I_D$      | 5.0      | A    |
|   |            | 2.9      |      |
|   | $I_{DP}$   | 13       |      |
| Single Pulsed Avalanche Energy (Note 2) | $E_{AS}$   | 270      | mJ   |
| Repetitive Avalanche Energy (Note 1)    | $E_{AR}$   | 8.6      | mJ   |
| Peak Diode Recovery dv/dt (Note 3)      | dv/dt      | 4.5      | V/ns |
| Drain Power Dissipation                 | $P_D$      | 83       | W    |
|   |            | 0.66     | W/   |
| Maximum Junction Temperature            | $T_j$      | 150      |      |
| Storage Temperature Range               | $T_{stg}$  | -55 150  |      |
| <b>Thermal Characteristics</b>          |            |          |      |
| Thermal Resistance, Junction-to-Case    | $R_{thJC}$ | 1.5      | /W   |
| Thermal Resistance, Junction-to-Ambient | $R_{thJA}$ | 62.5     | /W   |

**PIN CONNECTION**

# KF5N50PZ

## ELECTRICAL CHARACTERISTICS (Tc=25 °C)

| CHARACTERISTIC                            | SYMBOL                             | TEST CONDITION  | MIN. | TYP. | MAX. | UNIT |
|---|------------------------------------|---|------|------|------|------|
| <b>Static</b>                             |                                    |   |      |      |      |      |
| Drain-Source Breakdown Voltage            | BV <sub>DSS</sub>                  | I <sub>D</sub> =250μA, V <sub>GS</sub> =0V                                      | 500  | -    | -    | V    |
| Breakdown Voltage Temperature Coefficient | BV <sub>DSS</sub> / T <sub>j</sub> | I <sub>D</sub> =250μA, Referenced to 25   | -    | 0.55 | -    | V/°C |
| Drain Cut-off Current                     | I <sub>DSS</sub>                   | V <sub>DS</sub> =500V, V <sub>GS</sub> =0V,                                     | -    | -    | 10   | μA   |
| Gate Threshold Voltage                    | V <sub>th</sub>                    | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                        | 2.5  | -    | 4.5  | V    |
| Gate Leakage Current                      | I <sub>GSS</sub>                   | V <sub>GS</sub> =±25V, V <sub>DS</sub> =0V                                      | -    | -    | ±10  | μA   |
| Drain-Source ON Resistance                | R <sub>DS(ON)</sub>                | V <sub>GS</sub> =10V, I <sub>D</sub> =2.5A                                      | -    | 1.15 | 1.4  |      |
| <b>Dynamic</b>                            |                                    |   |      |      |      |      |
| Total Gate Charge                         | Q <sub>g</sub>                     | V <sub>DS</sub> =400V, I <sub>D</sub> =5A<br>V <sub>GS</sub> =10V<br>(Note 4,5) | -    | 12   | -    | nC   |
| Gate-Source Charge                        | Q <sub>gs</sub>                    |   | -    | 2.4  | -    |      |
| Gate-Drain Charge                         | Q <sub>gd</sub>                    |   | -    | 5.4  | -    |      |
| Turn-on Delay time                        | t <sub>d(on)</sub>                 | V <sub>DD</sub> =250V<br>R <sub>L</sub> =50<br>R <sub>G</sub> =25<br>(Note 4,5) | -    | 22.5 | -    | ns   |
| Turn-on Rise time                         | t <sub>r</sub>                     |   | -    | 29   | -    |      |
| Turn-off Delay time                       | t <sub>d(off)</sub>                |   | -    | 58   | -    |      |
| Turn-off Fall time                        | t <sub>f</sub>                     |   | -    | 18   | -    |      |
| Input Capacitance                         | C <sub>iss</sub>                   | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz                             | -    | 430  | -    | pF   |
| Output Capacitance                        | C <sub>oss</sub>                   |   | -    | 71   | -    |      |
| Reverse Transfer Capacitance              | C <sub>rss</sub>                   |   | -    | 7.5  | -    |      |
| <b>Source-Drain Diode Ratings</b>         |                                    |   |      |      |      |      |
| Continuous Source Current                 | I <sub>S</sub>                     | V <sub>GS</sub> <V <sub>th</sub>  | -    | -    | 5    | A    |
| Pulsed Source Current                     | I <sub>SP</sub>                    |   | -    | -    | 20   |      |
| Diode Forward Voltage                     | V <sub>SD</sub>                    | I <sub>S</sub> =5A, V <sub>GS</sub> =0V   | -    | -    | 1.4  | V    |
| Reverse Recovery Time                     | t <sub>rr</sub>                    | I <sub>S</sub> =5A, V <sub>GS</sub> =0V,<br>dI <sub>S</sub> /dt=100A/μs         | -    | 300  | -    | ns   |
| Reverse Recovery Charge                   | Q <sub>rr</sub>                    |   | -    | 4.8  | -    | μC   |

Note 1) Repetitive rating : Pulse width limited by junction temperature.

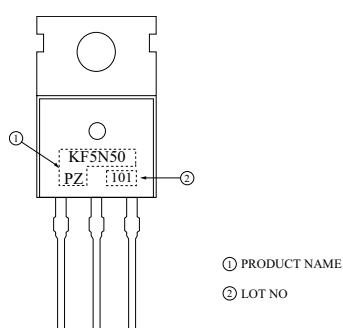
Note 2) L=19.5mH, I<sub>S</sub>=5A, V<sub>DD</sub>=50V, R<sub>G</sub>=25 , Starting T<sub>j</sub>=25 .

Note 3) I<sub>S</sub> 5A, dI/dt 100A/μs, V<sub>DD</sub> BV<sub>DSS</sub>, Starting T<sub>j</sub>=25 .

Note 4) Pulse Test : Pulse width 300μs, Duty Cycle 2%.

Note 5) Essentially independent of operating temperature.

## Marking



# KF5N50PZ

Fig1.  $I_D$  -  $V_{DS}$

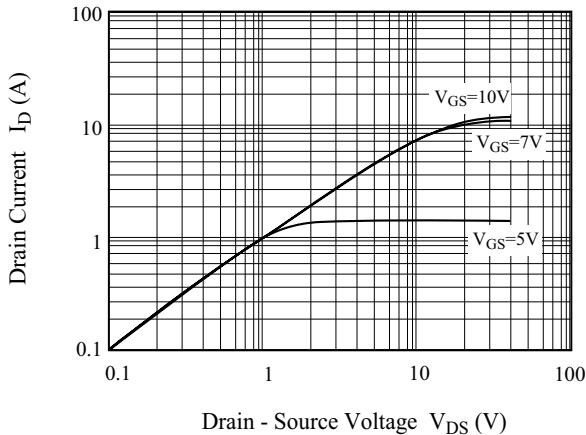


Fig2.  $I_D$  -  $V_{GS}$

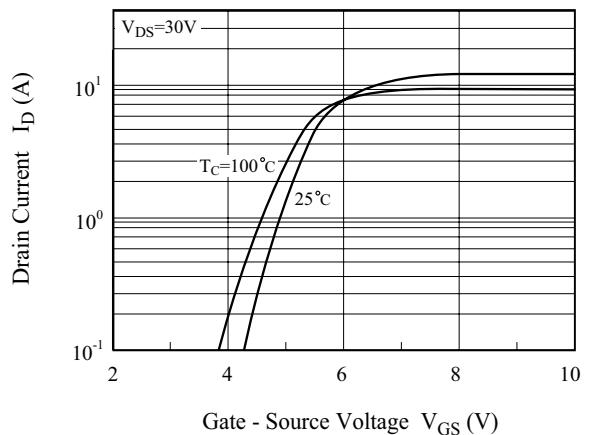


Fig3.  $BV_{DSS}$  -  $T_j$

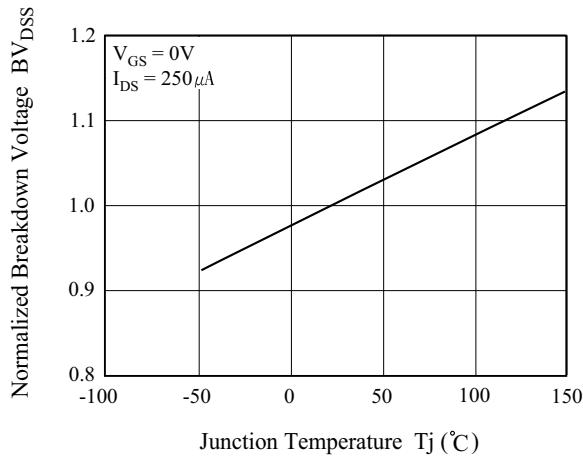


Fig4.  $R_{DS(\text{ON})}$  -  $I_D$

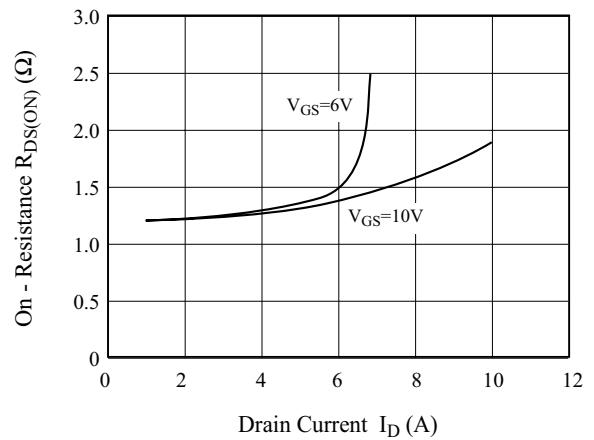


Fig5.  $I_S$  -  $V_{SD}$

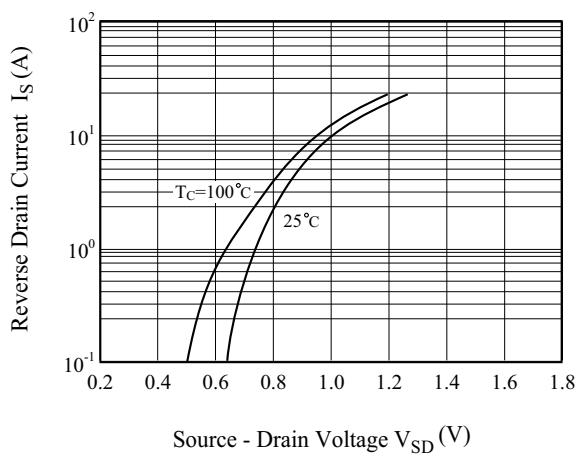
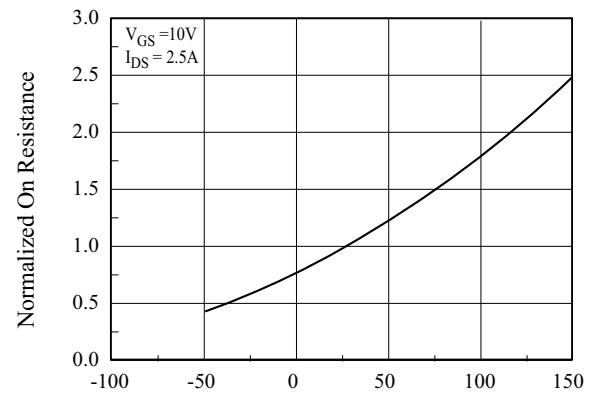


Fig6.  $R_{DS(\text{ON})}$  -  $T_j$



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Fig 7. C - V<sub>DS</sub>

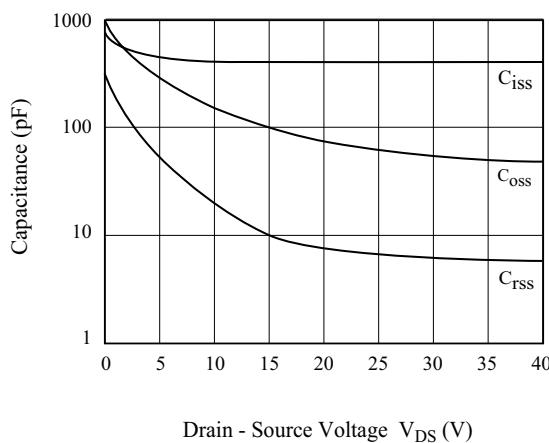


Fig8. Q<sub>g</sub>- V<sub>GS</sub>

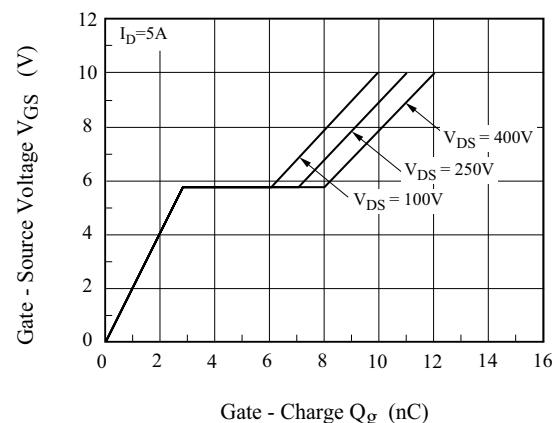


Fig9. Safe Operation Area

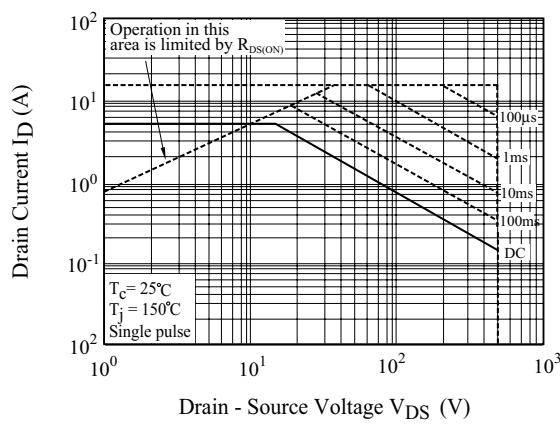


Fig10. I<sub>D</sub> - T<sub>j</sub>

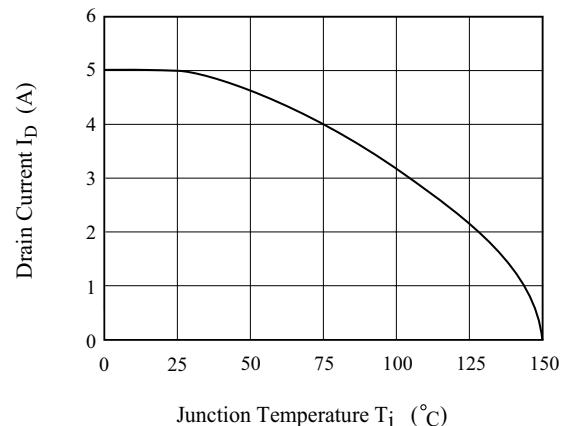
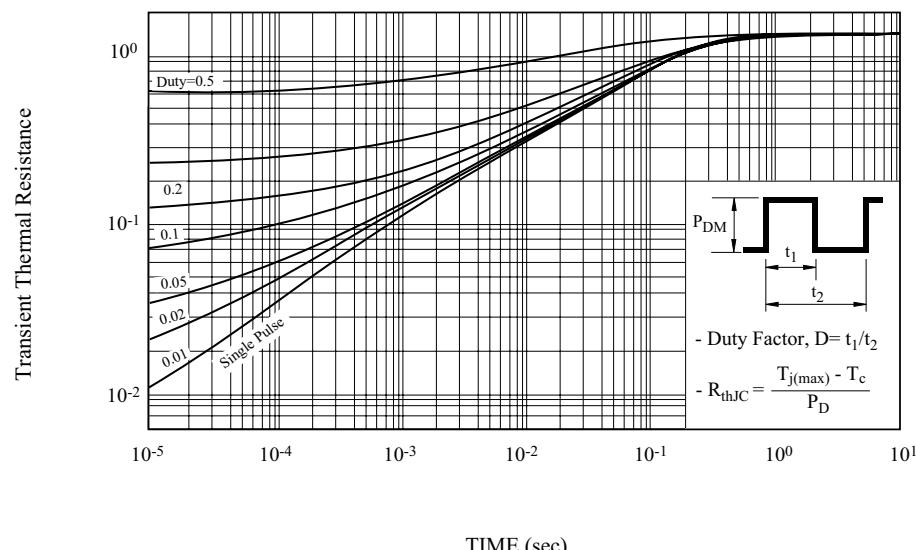


Fig11. Transient Thermal Response Curve



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Fig12. Gate Charge

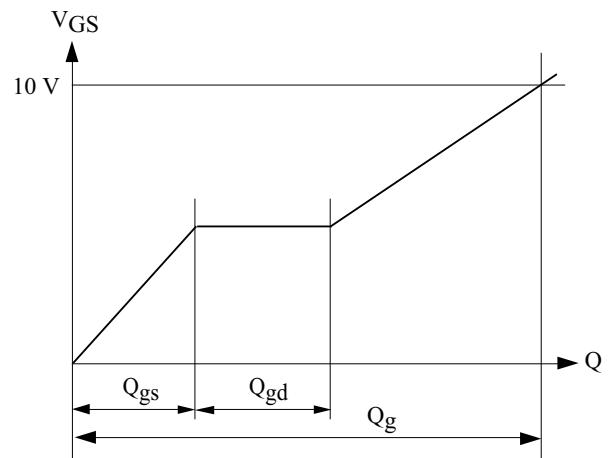
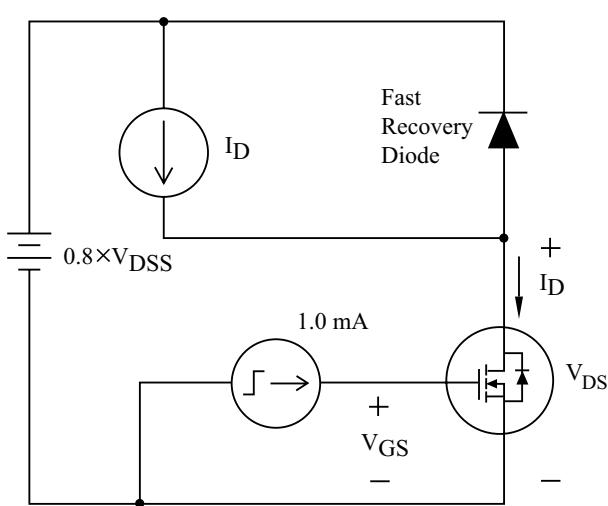


Fig13. Single Pulsed Avalanche Energy

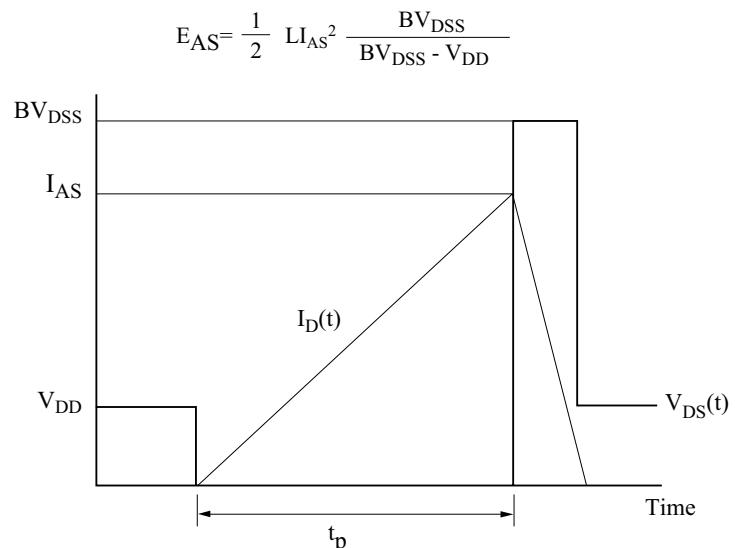
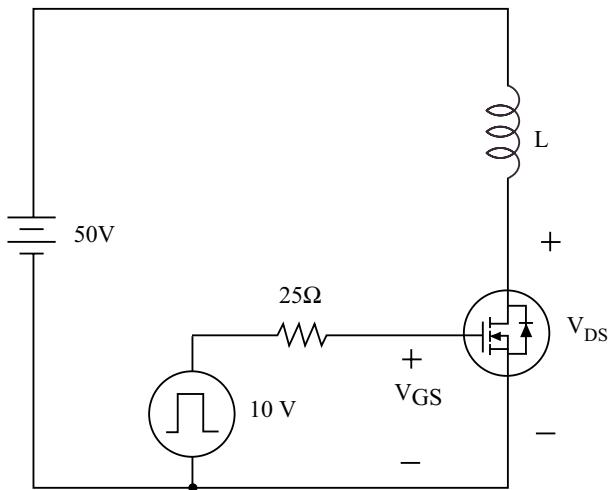
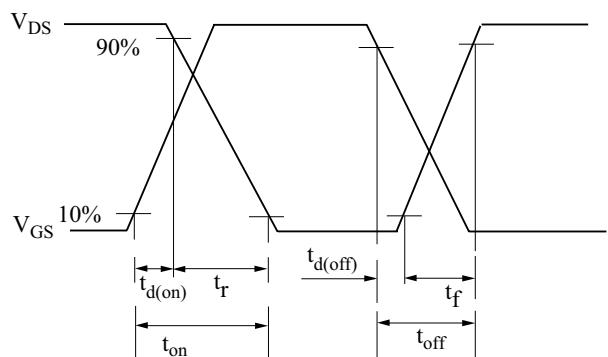
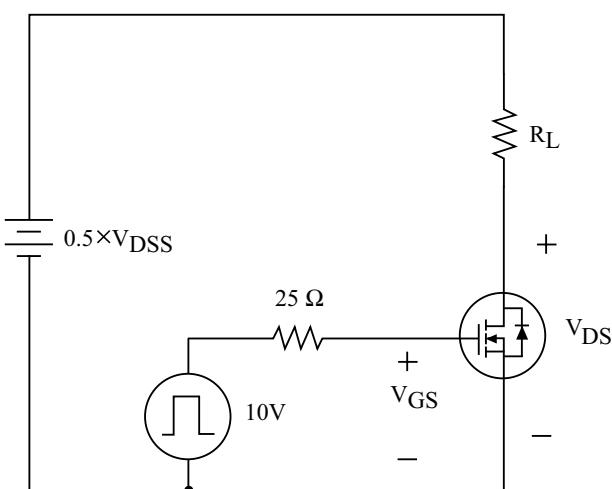


Fig14. Resistive Load Switching



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Fig15. Source - Drain Diode Reverse Recovery and dv /dt

